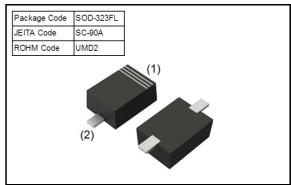


Zener Diode Data sheet

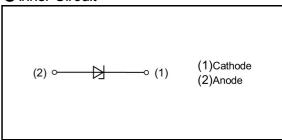
| $P_{D}$ | 200 | mW |
|---------|-----|----|

Outline



FeatureHigh reliabilitySmall mold type

Inner Circuit



ApplicationVoltage regulation

● Packaging Specification

| Prackaging Specification |               |  |  |  |
|--------------------------|---------------|--|--|--|
| Packing                  | Embossed Tape |  |  |  |
| Reel Size(mm)            | 180           |  |  |  |
| Taping Width(mm)         | 8             |  |  |  |
| Quantity(pcs)            | 3000          |  |  |  |
| Taping Code              | TE-17         |  |  |  |
| Marking                  | 4T            |  |  |  |

StructureSilicon Epitaxial Planar

● Absolute Maximum Rating (T<sub>a</sub> = 25°C)

| Parameter            | Symbol           | Limits    | Unit |
|----------------------|------------------|-----------|------|
| Power dissipation    | $P_{D}$          | 200       | mW   |
| Junction temperature | Tj               | 150       | °C   |
| Storage temperature  | T <sub>stg</sub> | -55 ~ 150 | °C   |

# ● Characteristic (T<sub>a</sub> = 25°C)

|           | Symbol                             |       |                                   |      |                                       |      |                    |
|-----------|------------------------------------|-------|-----------------------------------|------|---------------------------------------|------|--------------------|
| P/N       | Zener Voltage : V <sub>Z</sub> (V) |       | Dynamic Impedance : $Z_Z(\Omega)$ |      | Reverse Current : I <sub>R</sub> (µA) |      |                    |
|           | MIN.                               | MAX   | I <sub>z</sub> (mA)               | MAX  | I <sub>z</sub> (mA)                   | MAX. | V <sub>R</sub> (V) |
| UDZLV51   | 48.0                               | 54.0  | 2                                 | 180  | 2                                     | 1    | 39                 |
| UDZLV 56  | 53.0                               | 60.0  | 2                                 | 180  | 2                                     | 1    | 43                 |
| UDZLV62   | 58.0                               | 66.0  | 2                                 | 200  | 2                                     | 0.2  | 47                 |
| UDZLV68   | 64.0                               | 72.0  | 2                                 | 250  | 2                                     | 0.2  | 52                 |
| UDZLV75   | 70.0                               | 79.0  | 2                                 | 300  | 2                                     | 0.2  | 57                 |
| UDZLV82   | 77.0                               | 87.0  | 2                                 | 300  | 2                                     | 0.2  | 63                 |
| UDZLV91   | 85.0                               | 96.0  | 1                                 | 700  | 1                                     | 0.2  | 69                 |
| UDZLV 100 | 94.0                               | 106.0 | 1                                 | 700  | 1                                     | 0.2  | 76                 |
| UDZLV 110 | 104.0                              | 116.0 | 1                                 | 800  | 1                                     | 0.2  | 84                 |
| UDZLV120  | 114.0                              | 126.0 | 1                                 | 900  | 1                                     | 0.2  | 91                 |
| UDZLV130  | 122.0                              | 138.0 | 1                                 | 1250 | 1                                     | 0.2  | 102                |
| UDZLV 150 | 140.0                              | 160.0 | 1                                 | 1500 | 1                                     | 0.2  | 120                |

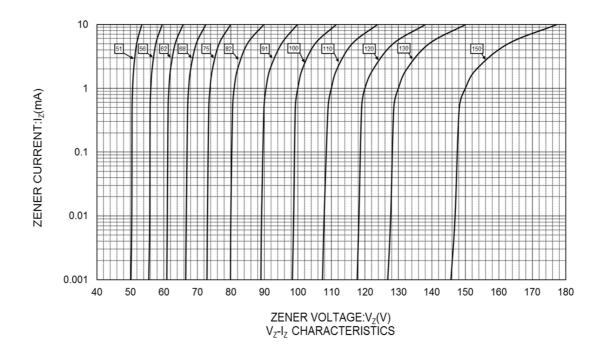
Zener voltage (V<sub>Z</sub>) is measured by applying current with 40ms pulse.

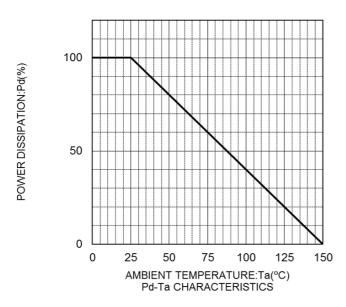
Dynamic resistance ( $Z_Z$ ) is measured by applying small current (AC) and specified current ( $I_Z$ ) simultaneously.

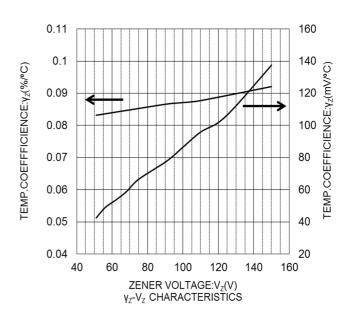
## Marking

| P/N      | Marking | P/N       | Marking |
|----------|---------|-----------|---------|
| UDZLV51  | 0T      | UDZLV91   | 6T      |
| UDZLV 56 | 1T      | UDZLV 100 | 7T      |
| UDZLV 62 | 2T      | UDZLV 110 | 8T      |
| UDZLV68  | 3T      | UDZLV 120 | 9T      |
| UDZLV75  | 4T      | UDZLV 130 | AT      |
| UDZLV82  | 5T      | UDZLV 150 | BT      |

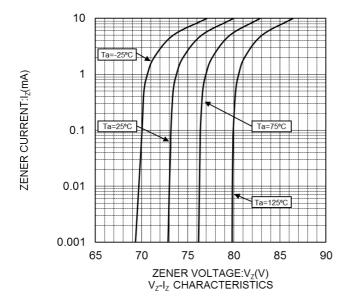
### Characteristic Curves

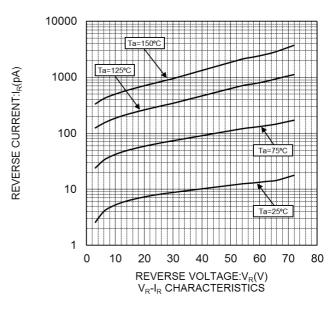


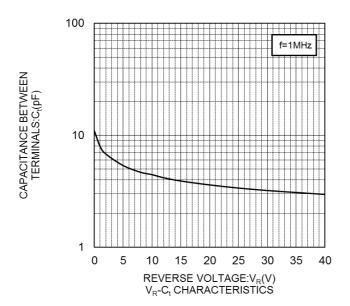


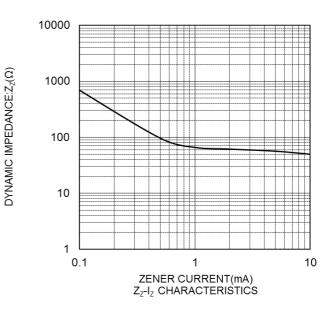


## Characteristic Curves

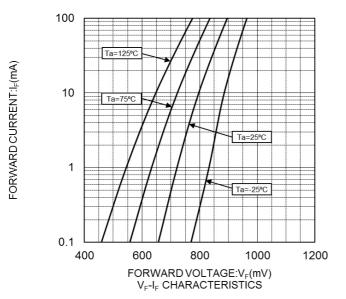


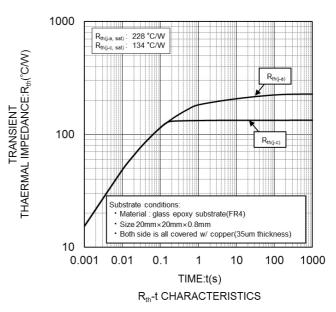




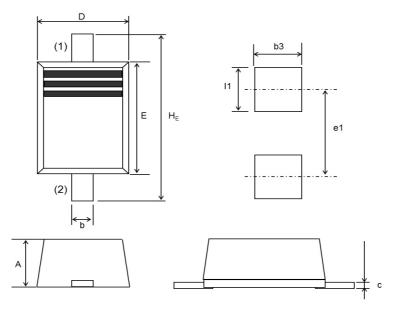


## Characteristic Curves





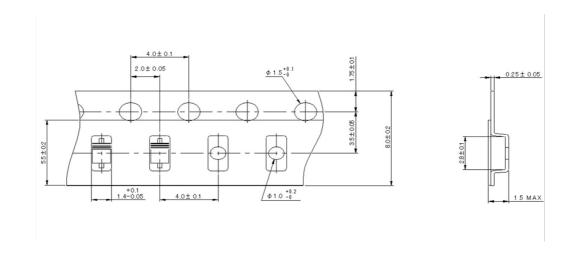
## ● Dimension (UMD2 SOD-323F SC-90A)



| DIM   | Milimeters |         | Inches |       |         |       |
|-------|------------|---------|--------|-------|---------|-------|
| DIIVI | Min.       | Average | Max.   | Min.  | Average | Max.  |
| А     | 0.60       | 0.70    | 0.90   | 0.024 | 0.028   | 0.035 |
| b     | 0.25       | 0.30    | 0.35   | 0.010 | 0.012   | 0.014 |
| С     | 0.05       | 0.10    | 0.20   | 0.002 | 0.004   | 0.008 |
| D     | 1.15       | 1.25    | 1.35   | 0.045 | 0.049   | 0.053 |
| Е     | 1.60       | 1.70    | 1.80   | 0.063 | 0.067   | 0.071 |
| HE    | 2.30       | 2.50    | 2.70   | 0.091 | 0.098   | 0.106 |
| I1    | 0.80       | -       | -      | 0.031 | -       | -     |
| b3    | 0.90       | -       | -      | 0.035 | -       | -     |
| e1    | -          | 2.10    | -      | _     | 0.083   | -     |

- (1) The marking bar indicates the cathode.(2) The direction indicates the anode.

## ● Taping (Unit:mm)



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| JAPAN   | USA      | EU         | CHINA       |  |
|---------|----------|------------|-------------|--|
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| CLASSIV | CLASSII  | CLASSⅢ     | CLASSⅢ      |  |

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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For details, please refer to ROHM Mounting specification

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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